

iNEMI 2017 Roadmap North American Workshop

*IEEE CPMT ECTC
Cosmopolitan Hotel
Room – Castellana 1
May 31, 2016
Las Vegas, NV*

iNEMI[®]
Advancing manufacturing technology

Preliminary Agenda

Tuesday, May 31, 2016

TIME:	TOPIC:	DISCUSSION LEADER:
7:50 AM	Welcome/Overview	Grace O'Malley, Chuck Richardson
8:20 AM	Environmentally Sustainable Electronics TWG	Matthew Chalkley
8:40 AM	Electronic Connectors TWG	John McWilliams
9:00 AM	MEMS/Sensors TWG	Michael Gaitan
9:20 AM	Solid State Illumination TWG	Gyan Dutt
9:40 AM	Discussion/Break	
10:00 AM	Board Assembly TWG	Paul Wang
10:20 AM	Semiconductor Technology TWG	Paolo Gargini
10:40 AM	Interconnect Substrates – Ceramic TWG	Howard Imhof
11:00 AM	Packaging & Component Substrates TWG	Bill Bottoms Raja Swaminathan
11:20 AM	Power Conversion Electronics TWG	Dhaval Dalal Connor Quinn
11:40 AM	Interconnect PCB – Organic TWG	Jack Fisher
12:00 PM	Optoelectronics TWG	Dick Otte
12:20 PM	Lunch/Discussion	

Preliminary Agenda(2)

Tuesday, May 31, 2016

TIME:	TOPIC:	DISCUSSION LEADER:
1:20 PM	Final Assembly TWG	Richard Henrick
1:40 PM	Passive Components TWG	Ed Mikoski
2:00 PM	Thermal Management TWG	Azmat Malik
2:20 PM	Flexible Hybrid Electronics TWG	Dan Gamota
2:40 PM	Discussion/Break	
3:00 PM	Mass Data TWG	Roger Hoyt
3:20 PM	Information Management TWG	Farid Anani
3:40 PM	Energy Storage TWG	Ravi Bhatkal
4:00 PM	Modeling, Simulation & Design Tools TWG	Lesley Polka
4:20 PM	Discussion/Break	
4:40 PM	Test, Inspection & Measurement TWG	Farouk Eshragi
5:00 PM	RF Components & Subsystems TWG	Tim Lee
5:20 PM	Summary/Close	Grace O'Malley